

(WITHOUT LED)

□東莞睦永電子五金廠

(WITH LED)

東莞愷興電子科技電子有限公司

Acron P/N:GDI60-N3-11**300

育鼎精密工業股份有限公司 ACRON PRECISION INDUSTRIAL CO., LTD

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(AMMI)			(ACRON)		(NUCONN)		
REVISION:	(ISION: ECR/ECN INFORMATION:		PRODUCT NO	GDI60-N	l3-11**300	SHEET No	
В	EC No: DATE:	RC-T170017 2017-01-12	PRODUCT NAME	Low profile single po	rt RJ45 10/100 Base-T	1 of 9	

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DOCUMENT NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:
PS-GD-0028	ANDELEE.YANG	JERRY.TUNG	KIMI.HSU



1.0 SCOPE

This Product Specification covers the performance requirements for Low profile single port RJ45 10/100 Base-T connector series.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Low profile single port RJ45 10/100 BASE-T series. Nuconn part No: GDI60-N3-11XX300,

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See appropriate sales drawings for details on dimensions, materials, plating and markings.

2.3 SAFETY AGENCY APPROVALS

See appropriate sales drawings

2.4 PRODUCT WEIGHT

The product weight is 5.72g

2.5 PRODUCING PLANT FACTORY AND ADDRESS

Producing plant factory: Nuconn Industry CORP. DongGuan Nuconn Industry CORP. Address:

Nr.32,RongFu Rd.,3rd Industrial District,ShangSha Village,,ChangeAn Town,DonGuan City, Guang Dong

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

Please refer to the Sales Drawings , and other sections of this Specification for specific references to applicable documents and specifications. In cases where the Product Specification differs from the Sales Drawings, the Sales Drawing will take precedence

3.1 TURNS RATIO:

(P2-P3): (J1-J2): 1CT:1CT±5% (P4-P5): (J3-J6): 1CT:1CT±5%

3.2 OPEN CIRCUIT INDUCTANCE:

(P2-P3): 360~580uH . @0.1V,100KHz, 8mA DC Bias (P4-P5): 360~580uH . @0.1V,100KHz, 8mA DC Bias

3.3 LEAKAGE INDUCTANCE:

P1-P2(Short J1-J2): 0.5 uH MAX, @1MHz P4-P5(Short J3-J6): 0.5 uH MAX, @1MHz

3.4 INTER-WINDING CAPACITANCE:

(P1,P2,P3) TO (J1,J2):35pf MAX, @1MHz (P4,P5,P6) TO (J3,J6):35pf MAX, @1MHz

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3.5 DC RESISTANCE:

(J1-J2) and (J3-J6): 1.2 ohms MAX

3.6 RETURN LOSS (LOAD 100 OHM)

1~30MHz:-18dB MIN 30~ 60MHz: -16dB MIN 60~ 80MHz: -12dB MIN

3.7. INSERTION LOSS

1~100MHz :-1.0dB Max

3.8. CROSS TALK:

1-100 MHz: -30dB MIN

3.9. COMMON TO COMMON MODE REJECTION:

1~100MHz: -35dB MIN

3.10. HI-POT:

UTP SIDE TO CHIP SIDE: 1500 Vrms or 2250VDC 60SEC@60Hz

3.11 TEMPERATURE

Operating Temperature Range: 0°C to +70°C

Storage Temperature Range: - 40°C to + 85°C

4.0 PERFORMANCE

Item	Test Items	Requirement	Procedures
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual, dimensional and functional per applicable quality inspection plan.

	Electrical Requirements								
2	LOW Level Contact Resistance	30 mΩ max initial $\Delta R = 30$ mΩ max final	Mate subject connector with compatible connector. EIA-364-23B						
3	Insulation Resistance	1000 M Ω min initial 50 M Ω min final	Apply 100±10% Volts DC between adjacent contacts of mated connectors for one minute. EIA-364-21						

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Dielectric 4 Withstanding Voltage

No discharge, flashover or breakdown. Current leakage: 1 mA max For mated specimens, 2250VDC or 1500Vrms 60 sec, between connected RJ interface contacts and all PCB tails connected together with shield. 1 milliamp ere cutoff current, 500 Volts per second maximum ramp. EIA-364-20

	Mechanical Requirements							
5	5 Mating and Un- mating Forces	Insertion Force:22N max Unlatched Withdrawal Force: 22N max	Measure force necessary to mate and un-mate connectors using the free floating fixtures at rate of 25mm/min.					
		Latched Withdrawal Force: 89N min	EIA-364-05B					
6	Solder ability	Wetting must occur over at least 95% of the solder immersion surface	Solder:SN/3.0Ag/0.5Cu,Flux:ROSIN 25%,IPA75%.High Temp Storage:150°C 1 hour, PCT: 105°C 100% 1.22*105Pa 4 hours. Solder 240°C±2°C; Immersion depth 2mm; Immersion time 3S					
7	Terminal Strength	Appearance meet requirement	Gravitation 500g , Winding 90 angle 2-3sec					
8	KOJIRI Strength	Appearance meet requirement	Left: 100N, push 15sec Right: 100N, push 15sec Up: 100N, push 15sec Down: 100N, push 15se					
9	Physical Shock	No electrical discontinuity greater than 1µsecond. Shall meet visual requirements, and show no physical damages.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. EIA-364-27B					
10	Durability	200 cycles with no function damage for RJ-45. Low Level Contact Resistance: ΔR = 30m Ω max final	The sample should be mounted in the tester and fully mated and unmated 300 times per hour at the rate of 25mm/min. EIA-364-09C					

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11	Random Vibration	No electrical discontinuity greater than 1µsecond. Shall meet visual requirements, and show no physical damages.	The electrical load condition shall be 100mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency which being varied uniformly between the approximate limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. EIA-364-28D
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	Environment Requirements								
12	Thermal Shock (Simulate Non- Operating State)	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to 100 cycles between -40°C and 85°C, 30 minutes duration at both temperature extremes. EIA-364-32C						
13	Humidity- Temperature Cycling	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Mated connectors placed in humidity chamber (Humidity 80-98%, Temperature 20-65°C) for 500 Hrs. EIA-364-31B, Method IV, Except 7a						
14	Temperature Life (Heat Aging)	\triangle R: $30m\Omega$ max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at 85°C for 500 hours. EIA-364-17B, Method A						
15	Temperature Life (Cold Aging)	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at-40°C for 500 hours EIA-364-17B, Method A						
16	Salt Spray	\triangle R: $30m\Omega$ max (change from initial) & Appearance: no damage	48hours Atmosphere: salt spray from a 5% solution. Temperature: 35 +1/-2°C EIA 364-26						
17	Damp Heat, Steady State	JIS C 0022 JEC Pub.68 2-3 Ca MIL-STD-202 103B	Test Temp :40±2°C Relative Humidity:90∼95%RH Test time:500Hrs						

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18	Change of Temperature	JIS C 0025 JEC Pub.68 2-14 NA MIL-STD-202 102A (Unless otherwise specified, either method 1or method 2. is to be closen)	Metod1
19	Ammonia	Appearance: no damage	Hydrogen Ion Exponent Index (PH)=10 Test Temperature:15~35℃ Test Time:72±4hrs
20	Soldering Heat	1: Electrical and mechanical performance must be satisfactory in specifications 2:There must no conspicuous changes in appearance(For example warping, swelling, cracking, indication)	MATERIALS Solder: Sn/99Ag/0.3/Cu0.7(Weight&) If no doubts araise in judgment, it is ok to use another SOLDER TEST CONDITION 1: TEST A: Flow Soldering (Partly Heating) 260±3℃ 10S ≦ 2: TEST B: Hand Soldering 400℃(Soldering iron tiop) 3S ≦

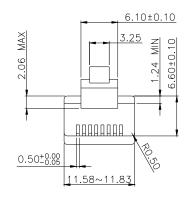
5.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. See packaging appropriate drawings

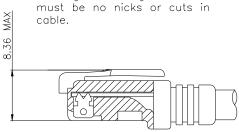
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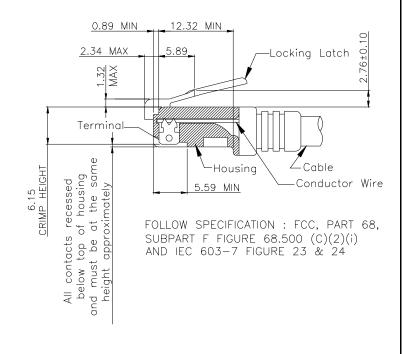
6.0 RECOMMENDED RJ PLUG SPECIFICATION



There must be no damage to housing or locking latch. There must be no nicks or cuts in cable.



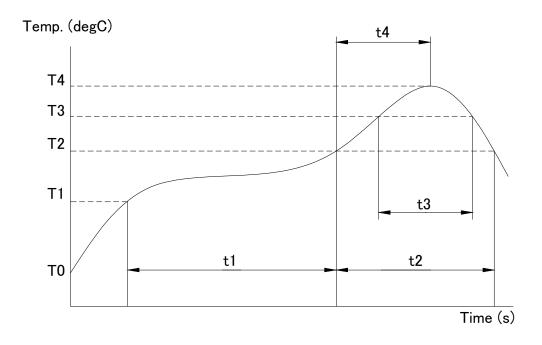
FOLLOW SPECIFICATION: FCC, PART 68, SUBPART F FIGURE 68.500 (C)(2)(ii)



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7.0RECOMMENDED REFLOW SOLDERING PROFILE

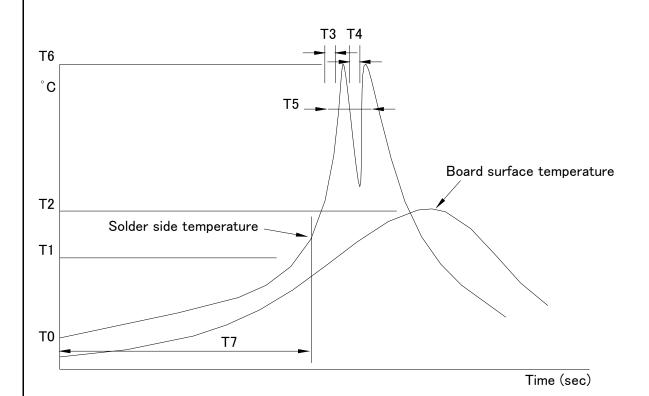


Start tempera	ature	ТО	35degC(Reference)	
Preheating	Temperature	T1-T2	150-195degC	
rronodenig	Time	t1	160sec.	
Heating time			115sec./195degC	
Heating time		t3/T3	60sec./225degC	
Peak tempera	ature	Т4	260degC	
Time to peak	temperature	Т4	40-90sec.	
Rate of rising	temperature	T0-T1	1-5degC/sec.	
Rate of rising temperature		T2-T4	1-3degC/sec.	
Peak tempera	ature(Soldering po	oints)	230degC	
Number of te	sts		3times	

8.0 RECOMMENDED WAVE SOLDERING PROFILE

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	T0	25~35°C (Room tempe	erature)
Start temperature	T1	90~120°C	
Pre-heat time	T7	MAX 180s	
Soldering time(solder side)	Т6	MAX 260+3°C	
Soldering temperature(board surface)	T2	MAX 150°C	cradle use
Soldering temperature(board surface)	T2	MAX 170°C	cradle no use
Soldering time	Т3	1st wave 1±0.5s	MAX temperature time
Soldering time	T4	2nd wave 3±1s	MAX temperature time
Max temperature arrival time	T7	180~210(MAX) s	
225°C over time	T5	3~15 s	
solder time		two time	

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ACRON 文件制訂、修訂、廢止申請單

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	RDP3-A-00/->=	>0	-		
文件編號	PS-GD-0028	文件名稱	G0760 -	N3-11	**300
申請部門	SD.	申請人	Tiowa.	日期	1.12 2017
制訂單位	研發部	制訂人	Antelee	日期	1.12 2017
制訂	EC No	. Rc-	T170017 (Rev. B	
修訂	Saj	lt Spraj	1 for 48 a	hours.	
□廢止原因說明		S2 4			
相關單位審查	Tran	1/12.		Indel.	1/12
核准			Simily's	2	